

# Enhanced photoresponse of Ge/Si nanostructures by combining amorphous silicon deposition and annealing

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In order to inhibit high carrier recombination rates in Ge-on-Si nanostructures,  $\text{Ge}_x\text{Si}_{1-x}$  nanoislands were covered by a thin amorphous silicon layer *via* a low pressure CVD process. It is demonstrated that the surface photovoltage (SPV) signal in capped  $\text{Ge}_x\text{Si}_{1-x}/\text{Si}$  is increased by an order of magnitude compared to that of bare  $\text{Ge}_x\text{Si}_{1-x}$  islands, which can be due to the effective passivation of recombination centers at the a-Si/ $\text{Ge}_x\text{Si}_{1-x}$  interface. The effect is even more enhanced after subsequent annealing at 400 °C in an  $\text{O}_2$  ambient environment, with the signal increases ranging from 5 to 10 times. The observed increased photovoltage is accompanied by longer time decays in the SPV transients, being most increased after the annealing step. These results show that the photoexcited electron-hole pairs can be efficiently separated by the internal electric field at the a-Si/ $\text{Ge}_x\text{Si}_{1-x}/\text{c-Si}$  interfaces and can contribute to the photovoltage with decreasing recombination in  $\text{Ge}_x\text{Si}_{1-x}$  islands or at the interfaces. This work can facilitate the photovoltaic applications of Ge/Si heterostructures. *Published by AIP Publishing.*

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## I. INTRODUCTION

Incorporating a small bandgap  $\text{Ge}_x\text{Si}_{1-x}$  layer, capable of absorbing more in the longer wavelengths of the solar spectrum, is attractive for increasing the overall photocurrent and efficiency of thin-film crystalline Si (c-Si) solar cells and photodetectors.<sup>1–5</sup> In order to avoid the lattice defect formation occurring upon relaxation of a SiGe-layer with a thickness larger than the critical thickness,<sup>6</sup> Ge layers can be grown to form three-dimensional islands or quantum dots in the Stranski-Krastanov growth mode.<sup>7</sup> Both increased response in the infrared and overall performance increase have been achieved with this approach,<sup>8</sup> which is of crucial importance for photovoltaic and electronic applications. These applications require embedded  $\text{Ge}_x\text{Si}_{1-x}$  species having very low defect densities and excellent optical and electronic properties.

In the c-Si material, the discontinuity of the crystal arrangement at the surface creates the dangling bonds, which act as good recombination centers and decrease the carrier lifetime.<sup>9</sup> To improve the efficiency for absorbing light and operating lifetime, the front surface of the solar cell normally consists of well-passivated antireflective coating of thermal  $\text{SiO}_2$  or  $\text{Si}_3\text{N}_4$  layers.<sup>10,11</sup>

In another approach, the amorphous silicon (a-Si) layers can be used as a top surface passivation coating for c-Si.<sup>12–18</sup> It has been reported that a-Si/c-Si heterostructures are advantageous with respect to enlarged separation lengths for photogenerated charge carriers,<sup>19</sup> as the desired minority carriers can be repelled from the interface, which reduces the recombination at the Si surface.

Quite recently, a-Si/c- $\text{Ge}_x\text{Si}_{1-x}$ /c-Si heterojunction solar cells have been proposed, which offer efficiencies superior to SiGe-based thin film solar cells.<sup>20</sup> It has been reported that placing a passivating a-Si:H thin layer on the front side of the  $n\text{-Si}_{0.85}\text{Ge}_{0.15}/p\text{-c-Si}$  heterojunction solar cell can passivate the front surface, which reduces the carrier recombination velocity at the front contact of the solar cell and increases the cell efficiency.<sup>21</sup> Electron transport by hopping conduction in terms of the carrier activation hopping over energy barriers has been observed in a-Si/c- $\text{Ge}_x\text{Si}_{1-x}/p\text{-c-Si}$  thin films although a thorough understanding of the conduction mechanism in these materials would be essential for their application in solar cells.<sup>22</sup>

However, there have been surprisingly a small number of studies concerned with the surface photovoltage (SPV) measurements and SPV decay times in a-Si/ $\text{Ge}_x\text{Si}_{1-x}$ /c-Si systems, which are of crucial importance for the design of photovoltaic, electronic, and optoelectronic devices.

In this work, we demonstrate that the SPV signal can be enhanced due to capping of  $\text{Ge}_x\text{Si}_{1-x}$  islands on Si with a-Si and after a subsequent annealing at 400 °C in an  $\text{O}_2$  ambient atmosphere. The observed enhancement is accompanied by longer time decays in the SPV transients. These results can be applied for optimizing the Si/Ge layer design in thin film solar cells.

## II. EXPERIMENTAL

To grow  $\text{Ge}_x\text{Si}_{1-x}$  on Si, electronic grade 300- $\mu\text{m}$  thick  $p\text{-type Cz-Si}(100)$  wafers with a mirror surface on the front side and chemical polishing on the back side were used. Their resistivity was 10  $\Omega\text{cm}$ , and approximate bulk lifetime measured from the photocurrent decay was about 700  $\mu\text{s}$ . First, an ex-situ standard RCA cleaning process with HF dip

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last treatment and a  $\text{H}_2$  prebake at  $1000^\circ\text{C}$  to remove native oxide were carried out. Without exposing the wafer to air, a 5 nm thick masking chemical vapor deposition (CVD) oxide was grown on the cleaned substrate. Here, an ultra-thin, porous  $\text{SiO}_2$  layer was used to achieve an epitaxial growth of germanium nano-dots with densities exceeding  $10^{12}\text{ cm}^{-2}$  through existing nano-windows.<sup>23</sup>

The Ge deposition was performed in the reduced pressure CVD system under the same process conditions as described elsewhere.<sup>24,25</sup> The initial Ge seed layer was grown at  $300^\circ\text{C}$  using a  $\text{N}_2\text{-GeH}_4$  gas mixture. Then, the wafer was heated up to  $550^\circ\text{C}$  in  $\text{H}_2$  and the Ge growth was continued with a  $\text{H}_2\text{-GeH}_4$  gas mixture, resulting in a 7 monolayer thick ( $\approx 2.3\text{ nm}$ )  $\text{Ge}_x\text{Si}_{1-x}$  layer (referred to later as sample set G).

In a strained  $\text{Ge}_x\text{Si}_{1-x}$  layer grown on Si, isolated islands can be formed, as described in detail elsewhere.<sup>26,27</sup> These islands were characterized using a scanning probe atomic force microscope (AFM) NanoScope IIIa. The resulting images are exemplified in Fig. 1.

These samples were subsequently surface-coated with 10-nm thick a-Si layers by low pressure CVD (referred to as sample set  $G_2$ ). This was done by using the thermal decomposition of silane,  $\text{SiH}_4 = \text{Si} + 2\text{H}_2$ , at  $520^\circ\text{C}$ .<sup>28</sup> To study the influence of the thermal treatment, the  $G_2$  samples were additionally furnace annealed for 5 minutes at  $400^\circ\text{C}$  in an  $\text{O}_2$  ambient atmosphere (sample set  $G_2^1$ ).

SPV transients were measured in the capacitor arrangement using a red light-emitting diode (LED) with a pulse width of 100 ns as an excitation source. Details of our setup are given elsewhere.<sup>29</sup> A parallel plate capacitance was formed between a metal grid electrode with a transparency of  $\leq 30\%$  and the structure, separated by a mica insulating foil with a thickness of about  $20\text{ }\mu\text{m}$ . A 1-G $\Omega$  load resistor, a high-impedance buffer cascade (input resistance  $10^{13}\text{ }\Omega$ , output resistance  $50\text{ }\Omega$ ) based on a field-effect transistor, and a sampling digital oscilloscope were used in the measurements. The measuring circuit was carefully screened to ensure that the experimental system was not susceptible to electronic pickups or ground loop effects. The scanning SPV apparatus, which provides wafer maps of both the SPV magnitude and decay time with a  $100\text{-}\mu\text{m}$  spatial resolution, was

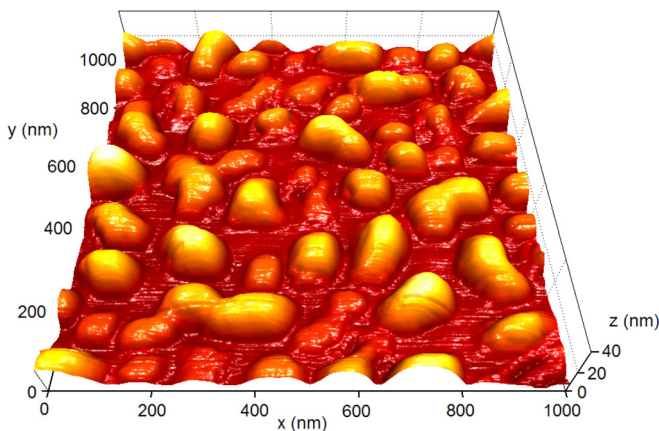


FIG. 1. AFM image of the surface of sample G.

discussed elsewhere.<sup>30</sup> The scanning area for each sample was  $4\text{ mm} \times 7\text{ mm}$ .

Raman spectra were collected at room temperature using a Horiba Jobin-Yvon T-64000 Raman spectrometer equipped with a TE-cooled CCD detector. The 488.0 nm line of the  $\text{Ar}^+/\text{Kr}^+$  laser was used for excitation. Measurements were performed in the  $z(x,y)\bar{z}$  scattering geometry, where  $x$ ,  $y$ , and  $z$  correspond to the crystallographic directions  $[100]$ ,  $[010]$ , and  $[001]$  of Si, respectively.

### III. RESULTS AND DISCUSSION

While Ge island alloying during deposition takes place at the interface with the Si substrate, the Si removed from the substrate diffuses into the growing islands, resulting in Ge-rich  $\text{Ge}_x\text{Si}_{1-x}$  islands in sample G. When the samples are capped with a 10 nm a-Si layer (samples  $G_2$  and  $G_2^1$ ), the Si interdiffusion from the capping layer may occur, which may lead to a further increase in the Si content in the islands. Here, we address this issue by using Raman scattering to analyze the optical phonon region and extract the average Ge content  $x$  in the  $\text{Ge}_x\text{Si}_{1-x}$  islands.

Figure 2 shows Raman spectra of our samples. There are two distinct peaks centered near  $\omega_1 \approx 300\text{ cm}^{-1}$  and  $\omega_2 \approx 405\text{ cm}^{-1}$ , which are due to the scattering from optic phonons involving Ge-Ge and Si-Ge vibrations, respectively.<sup>31</sup> It is seen that their frequencies,  $\omega_1$  and  $\omega_2$ , slightly vary in different sample sets (see Table I), indicative of varying average strain and composition in  $\text{Ge}_x\text{Si}_{1-x}$ .

The frequencies of the two modes can be fitted *via* varying the Ge fraction  $x$  and strain as follows:<sup>32</sup>

$$\omega_1 = 284 + 5x + 12x^2 + b_1 \langle S_{\parallel} \rangle, \quad (1)$$

$$\omega_2 = 400 + 29x - 95x^2 + 213x^3 - 170x^4 + b_2 \langle S_{\parallel} \rangle, \quad (2)$$

where  $\langle S_{\parallel} \rangle$  is the average in-plane strain,  $b_1 = -400\text{ cm}^{-1}$  is the phonon strain-shift coefficient for the Ge-Ge mode, and  $b_2 = -575\text{ cm}^{-1}$  is that for the Si-Ge mode.<sup>31,33</sup> This calculation yields the  $x$  and  $\langle S_{\parallel} \rangle$  values, which are given in Table I.

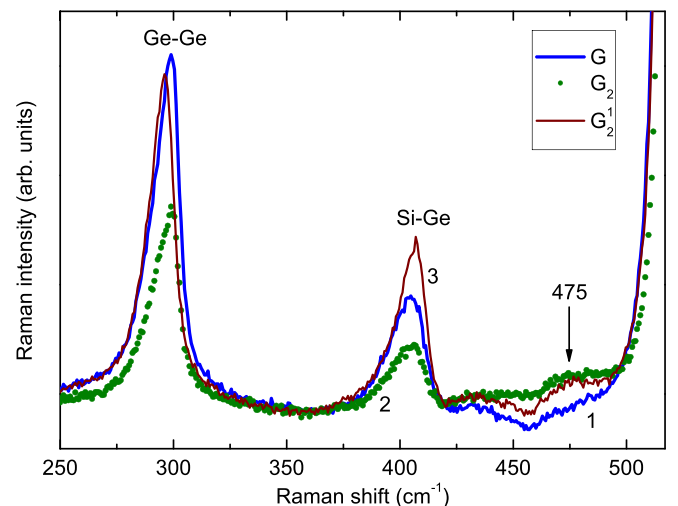


FIG. 2. Raman spectra of samples G (1),  $G_2$  (2), and  $G_2^1$  (3).

TABLE I. Frequencies of the Raman modes and calculated values of  $x$  and  $\langle S_{\parallel} \rangle$ .

Sample	$\omega_1$ (cm <sup>-1</sup> )	$\omega_2$ (cm <sup>-1</sup> )	$x$	$\langle S_{\parallel} \rangle$ (%)
G	298.9	404.6	0.818	-0.69
G <sub>2</sub>	299.1	405.0	0.817	-0.75
G <sub>2</sub> <sup>1</sup>	296.0	406.3	0.753	-0.36

It is seen that the concentration of Ge atoms in the Ge<sub>x</sub>Si<sub>1-x</sub> islands is about 82% for sample G. After capping with a 10 nm a-Si layer in sample G<sub>2</sub> the Ge content is preserved, whereas subsequent annealing at 400 °C in an O<sub>2</sub> ambient atmosphere decreases the Ge fraction down to about 75%.

It is well known that the surface photovoltage monitors the excess carrier density adjacent to the surface.<sup>34</sup> If we consider long enough light pulse widths, greater than the carrier lifetime  $\tau$ , the penetration depth of the minority carriers is of the order of the minority carrier diffusion length  $L$ , which is related to  $\tau$  as  $L = \sqrt{D\tau}$  with  $D$  the diffusion coefficient. Furthermore, if the recombination lifetime in the near-surface space charge region is greater than the recombination lifetime in the bulk, the surface density of excess carriers decays with the same time constant as carriers elsewhere in the sample.

In our case, the light pulse width was chosen to be much smaller than  $\tau$ . As shown by Luke and Cheng,<sup>35</sup> the minority-carrier profile below the surface is determined by  $1/\alpha$  ( $\approx 3 \mu\text{m}$  at the light absorption coefficient  $\alpha = 3.1 \times 10^3 \text{ cm}^{-1}$  in c-Si<sup>36</sup>) rather than by the diffusion length  $L$ . Therefore, the SPV decay is determined mostly by the recombination lifetime in the space charge region, and the observed changes in the SPV decay times and magnitudes are primarily related to the near-surface recombination processes modified by the deposition of a-Si and subsequent annealing.

Figure 3 shows SPV decays obtained in our samples. They are taken by averaging over the light beam diameter of

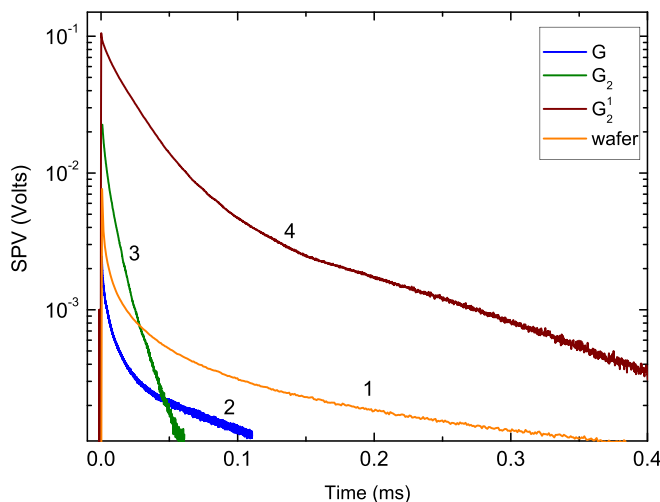


FIG. 3. Time-dependent SPV of Si wafer (1), samples G (2), G<sub>2</sub> (3), and G<sub>2</sub><sup>1</sup> (4). The decays are taken with unfocused 640-nm LED light striking the sample surface, about 5 mm in diameter.

about 5 mm in order to reproduce the behavior of a solar cell capable of converting unfocused solar energy into electricity. It is seen that most of the decays are non-exponential, as, seemingly, only curve 3 more closely resembles the single exponent.

The most prominent effect in Fig. 3 is the SPV enhancement due to capping sample G with a-Si (curves 3 and 4 compared with curves 1 and 2 at time  $t=0$ ). It is seen that the SPV magnitude is increased by an order of magnitude in the capped Ge<sub>x</sub>Si<sub>1-x</sub>/Si (curve 3 at time  $t=0$ ) compared to that of bare Ge<sub>x</sub>Si<sub>1-x</sub> islands (curve 2), and the effect is even more enhanced after subsequent annealing in an O<sub>2</sub> ambient atmosphere, ranging from about 5 to 10 times increase (curve 4 at time  $t=0$ ).

A recent survey of most common models used to describe carrier decay processes is given by Gaubas *et al.*<sup>37</sup> For example, a simple double-exponential carrier decay transient can be observed due to carrier trapping. At low excess carrier densities, the solution of the rate equations for free carriers and those trapped on shallow levels leads to the effective excess carrier decay lifetime of recombination with trapping, which is determined by three partial lifetimes of recombination through deep levels, carrier trapping at shallow levels, and thermal release from shallow levels.

However, we anticipate that the behavior of photoexcited charge carriers at the surface shown in Fig. 1 can be better described by multi-trapping of charge carriers in disordered systems. It is known that disordered structures of different types lead to more complicated carrier decay transients, which are often due to trapping-limited diffusion in randomly distributed sinks.<sup>38-40</sup> It is quite evident that the observed SPV decay can be viewed as due to recombination not only through centers in the islands and a-Si layer but also through states at the Ge<sub>x</sub>Si<sub>1-x</sub>/SiO<sub>2</sub> and a-Si/Ge<sub>x</sub>Si<sub>1-x</sub> interfaces. It is important to note that, in the case of a distribution of decay times, e.g., due to a distribution of the energies of these states and of the dynamics of carrier capture and emission, non-exponential decay characteristics may be obtained. Then, for various distributions of the decay times, the resulting behavior yields various temporal dependencies of the SPV.

Such a decay time distribution can be described by a stretched-exponential decay model,<sup>41</sup> so that the decay curves given in Fig. 3 were fitted to a stretched-exponential time decay,

$$U(t) = U_0 e^{-(t/\tau_0)^\beta}, \quad (3)$$

with the characteristic stretched-exponent decay time  $\tau_0$  and the dispersion factor  $\beta$ , which describes the spread of time constants. Thus,  $\beta = 1$  for a monoexponential decay, while a stretching parameter  $0 < \beta < 1$  describes a variation from a monoexponential transient such that the smaller value of  $\beta$  corresponds to the broader distribution of decay times.

More detailed information can be derived by analyzing the spatially distributed  $\tau_0$  and  $\beta$ , which are shown in Figs. 4 and 5. The maps give spatially inhomogeneous  $\tau_0$  and  $\beta$ , which are most likely a consequence of the fabrication



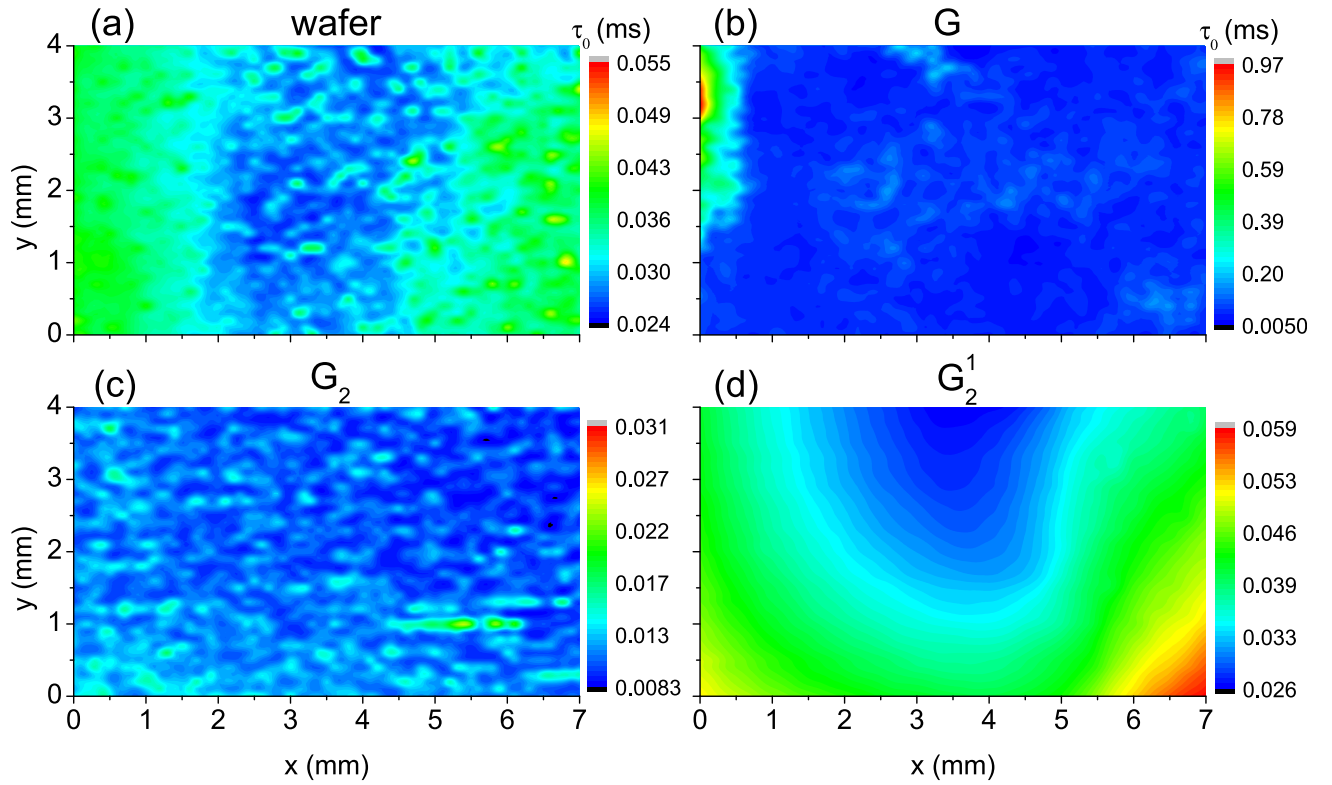


FIG. 4. Maps of the surface distribution of  $\tau_0$  in Si wafer (a), samples G (b),  $G_2$  (c), and  $G_2^1$  (d). The decays are taken with a LED light focused to a spot of  $100\ \mu\text{m}$  in diameter.

process and treatment steps, although quantitative conclusions are hardly feasible. Nevertheless, the general result is that the values of  $\tau_0$  and  $\beta$  are markedly non-uniform after capping with a 10 nm a-Si layer in sample  $G_2$ , as evidenced

by images (c) in Figs. 4 and 5. Images (d) in Figs. 4 and 5 show much more homogeneous distribution of  $\tau_0$  and  $\beta$ , as ripple patterns most clearly seen in Figs. 4(c) and 5(c) are remarkably obscured.

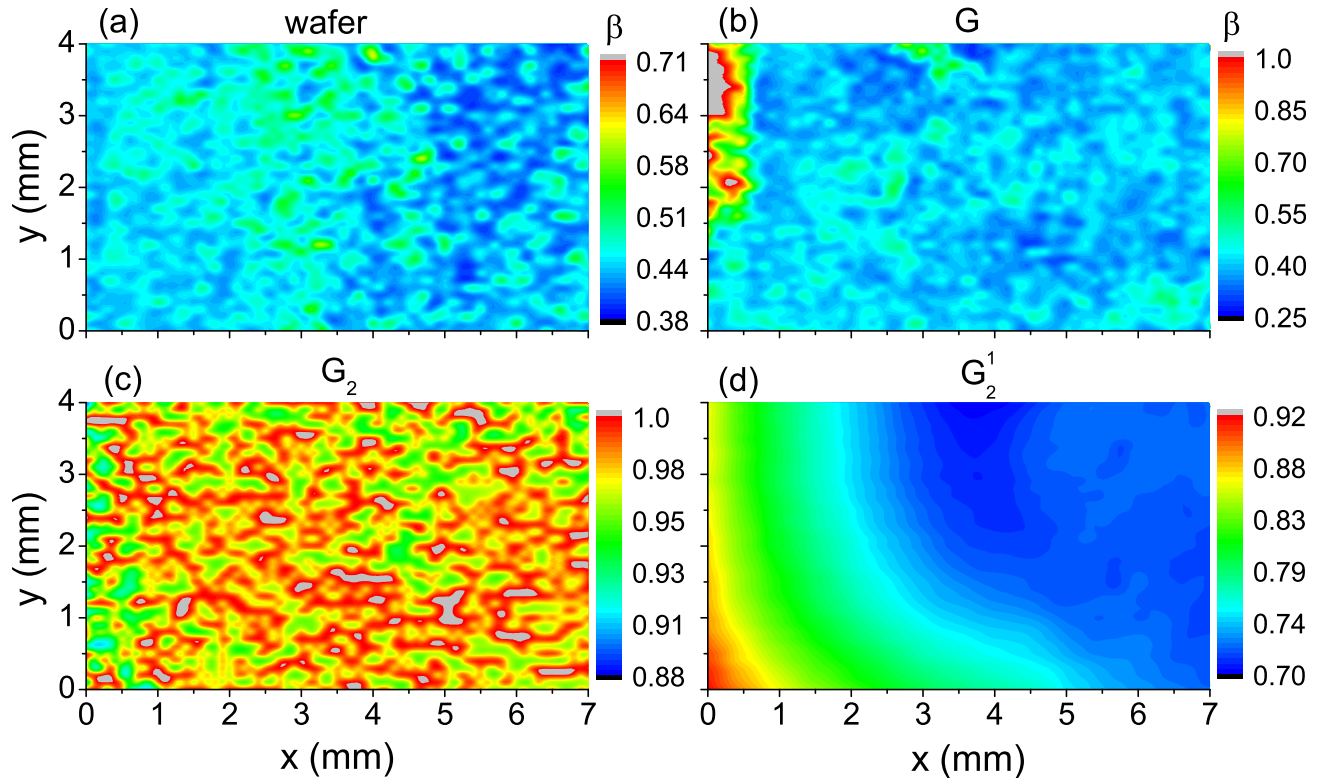


FIG. 5. Maps of the surface distribution of  $\beta$  in Si wafer (a), samples G (b),  $G_2$  (c), and  $G_2^1$  (d). The decays are taken with a LED light focused to a spot of  $100\ \mu\text{m}$  in diameter.

By statistically analyzing the images shown in Figs. 4 and 5, we compute the probabilities to find particular values of  $U_0$ ,  $\tau_0$ , and  $\beta$  in Eq. (3), which allow drawing useful conclusions about the surface-distributed SPV decay times and the effect of passivating the interface states at the surface of the  $\text{Ge}_x\text{Si}_{1-x}$  islands and at the buried interfaces.

The values of  $U_0$  and characteristic time constants  $\tau_0$  for all our samples are plotted in Fig. 6, whereas the values of the  $\beta$  factor are shown in Fig. 7. For comparison, we also show the  $U_0$ ,  $\tau_0$ , and  $\beta$  distributions reproduced in the Si wafer, which served as a freshly prepared substrate for growing our nanostructures; see Figs. 6(a) and 7(a).

The main effects are clearly revealed in Figs. 6(a) and 6(b). Depositing a porous  $\text{SiO}_2$  layer and, subsequently,  $\text{Ge}_x\text{Si}_{1-x}$  islands (sample G) quenches the SPV signal making it noticeably broader, as shown in Figs. 6(a) and 6(b). The  $\tau_0$  distribution becomes significantly narrower, as evidenced by insets in Figs. 6(a) and 6(b). A rather complicated interface structure in our  $\text{Ge}_x\text{Si}_{1-x}$ -on-Si sample yields that the measured decay times are non-uniformly distributed across the wafer surface, so that much longer  $\tau_0$ , up to  $\approx 1$  ms, can be realized in sample G, as seen in the inset of Fig. 6(b) and in Fig. 4(b).

Another important clue can be observed in Fig. 7. While the  $\beta$  distribution peak for sample G decreases in intensity

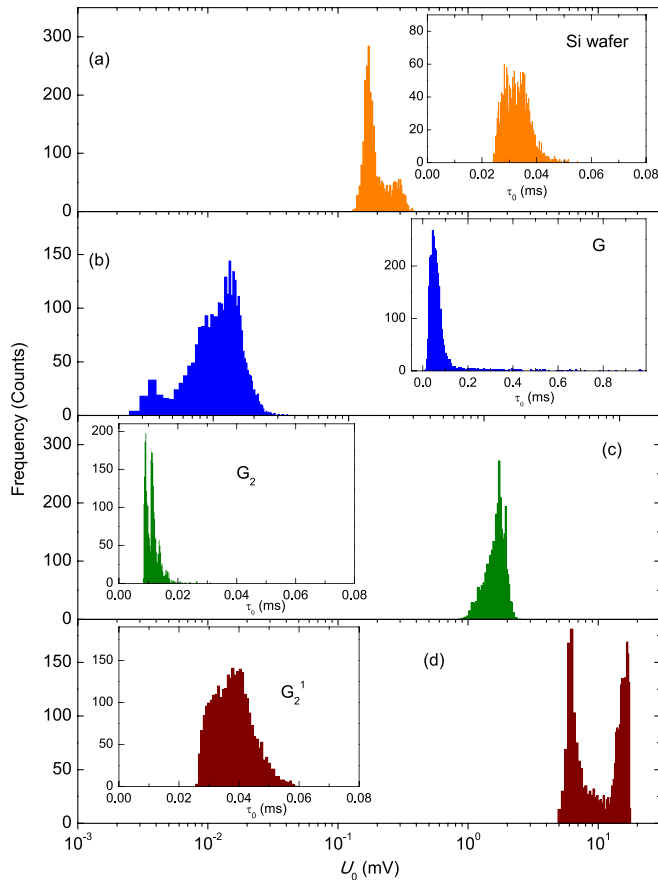


FIG. 6. Probability of occurrences of a particular values of  $U_0$  and  $\tau_0$  (insets) in Si wafer (a), samples G (b),  $G_2$  (c) and  $G_2^1$  (d), which are measured by surface mappings of the SPV decays. The values of  $U_0$  and  $\tau_0$  are obtained by fitting all the surface-collected decays to a stretched-exponential form. The decays are taken with a LED light focused to a spot of  $100 \mu\text{m}$  in diameter.

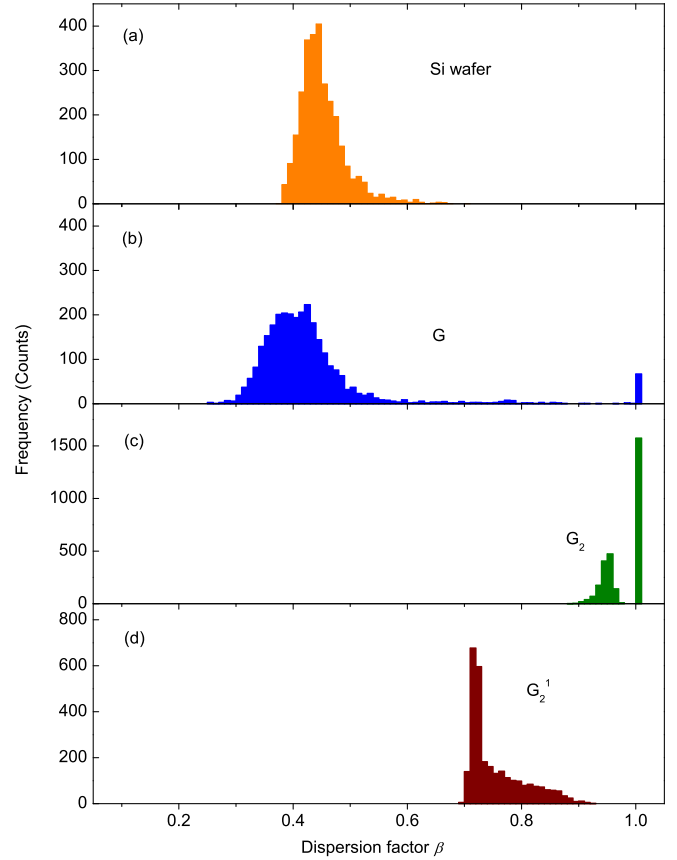


FIG. 7. Probability of occurrences of a particular value of  $\beta$  in Si wafer (a), samples G (b),  $G_2$  (c), and  $G_2^1$  (d). The measurement conditions are similar to those in Fig. 6.

and slightly shifts to smaller values in Fig. 7(b) compared to that in the wafer given in panel (a), some of the carrier decay channels in sample G produce a monoexponential decay with  $\beta = 1$ , which can thus be viewed as being nearly contained within a perfect  $\text{Ge}_x\text{Si}_{1-x}/\text{Si}$  interface.<sup>42</sup>

This effect is even more pronounced after the  $\text{Ge}_x\text{Si}_{1-x}$  islands were coated with amorphous silicon in sample  $G_2$ , as seen in Fig. 7(c). The  $\beta$  distribution peak is drastically suppressed with the peak position shifted towards  $\beta = 1$ . Gaining the strength, as evidenced by increased  $U_0$  in Fig. 6(c), the SPV signal decays nearly monoexponentially [strong peak at  $\beta = 1$  in Fig. 7(c)], which is also seen in curve 3 of Fig. 3 exhibiting the monoexponential decay.

We can attempt to understand the effect by taking into account that hydrogenated amorphous silicon films have outstanding passivation effects in crystalline silicon surfaces, and insertion of an ultrathin  $\text{SiO}_x$  layer at the a-Si:H/c-Si interface has significant influences on the passivation effect.<sup>43</sup> The  $\text{SiO}_x$  layer serves as a barrier to prevent the epitaxial growth of a-Si:H at a nonsharp a-Si:H/c-Si interface, thus improving the quality of the a-Si:H/c-Si interface.

In order to clarify the likely involvement of the  $\text{SiO}_x$  species, an additional annealing step at  $400^\circ\text{C}$  in an  $\text{O}_2$  ambient atmosphere (sample  $G_2^1$ ) was done. After our samples were annealed at  $400^\circ\text{C}$ , both the SPV magnitude  $U_0$  and the decay time  $\tau_0$  remarkably increase, spreading out over greater intervals; see Fig. 6(d). The contribution of the

monoexponential decays drops at the expense of the strong peak at about  $\beta = 0.7$ , as shown in Fig. 7(d). An increase in the SPV signal taken in sample  $G_2^1$  is accompanied by longer time decays in the SPV transients [(d) in Fig. 6] over those for samples G and  $G_2$  [(b) and (c) in Fig. 6, respectively].

Based on the above derivations, we now consider a schematic sketch of the  $\text{Ge}_x\text{Si}_{1-x}$  islands and the buried interfaces (see Fig. 8) that can explain the observed SPV results. We suggest that the strain, which arises in the growing  $\text{Ge}_x\text{Si}_{1-x}$  layer at the  $\text{Ge}_x\text{Si}_{1-x}/\text{SiO}_2$  interface ( $\langle S_{\parallel} \rangle$  in Table I), worsens the quality of the a-Si:H/ $\text{Ge}_x\text{Si}_{1-x}$  interface. This creates micro void regions with dangling and floating bonds in the island/surrounding matrix environment, which form randomly distributed sinks acting as undesirable recombination centres. The annealing step at 400 °C in an  $\text{O}_2$  ambient atmosphere done in sample  $G_2^1$  allows for a partial strain relaxation, as supported by the Raman data given in Table I ( $\langle S_{\parallel} \rangle = -0.36\%$  in sample  $G_2^1$  compared with  $\langle S_{\parallel} \rangle = -0.75\%$  in sample  $G_2$ ). This annealing may oxidize a-Si and form the above  $\text{SiO}_x$  species thus improving the quality of the  $\text{Ge}_x\text{Si}_{1-x}/\text{SiO}_2$  interface.

The second important feature is related to the direct saturation of the surface dangling bonds shown in Fig. 8 by the oxygen passivating particles that diffuse into the island/surrounding matrix environment. Third, the  $\text{Ge}_x\text{Si}_{1-x}/\text{Si}$  interface quality is improved due to the passivation by H. Hydrogen diffusion occurs laterally across the  $\text{Ge}_x\text{Si}_{1-x}$  and  $\text{SiO}_2$  surfaces and beneath the a-Si:H thin layer by localized hopping,<sup>44</sup> where the hydrogen absorbed at one site jumps to another site *via* shallow trapping states. Reaching the  $\text{Ge}_x\text{Si}_{1-x}/\text{Si}$  interface, hydrogen passivates the interface defects, which in turn improves the interface quality and enhances the photoresponse.

Therefore, these results show that the photoexcited electron-hole pairs are efficiently separated at the a-Si/ $\text{Ge}_x\text{Si}_{1-x}/\text{c-Si}$  interfaces contributing to SPV with decreasing recombination in the island/surrounding matrix. The recombination time can be defined as  $\tau_r = \Delta n/R$ , where  $\Delta n$  is the excess carrier density and  $R$  is the recombination rate. Then, the SPV signal magnitude is  $U_0 = (e\Delta n/\epsilon\epsilon_0)L$ , where  $\epsilon$  is the dielectric function,  $\epsilon_0$  is the permittivity of free space,  $e$  is the elementary charge, and  $L$  is the charge separation length. This yields

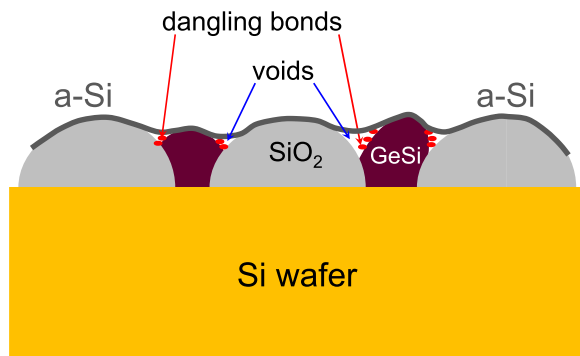


FIG. 8. Schematics of the a-Si/ $\text{Ge}_x\text{Si}_{1-x}/\text{Si}$  structure illustrating the Si substrate, porous  $\text{SiO}_2$ , GeSi islands, and a-Si layer with dangling bonds at the island surface in micro voids.

$$U_0 = \frac{e\tau_r RL}{\epsilon\epsilon_0}, \quad (4)$$

expressing the trend that increasing  $U_0$  would increase  $\tau_r$  and thus prolong the SPV decay times, which is indeed the case in Fig. 3.

It has been shown that crystallization of a-Si:H may occur at the temperatures employed in this work.<sup>45–48</sup> In order to address this issue, Raman spectra of the sample surface in the range from  $\approx 440$  to  $600\text{ cm}^{-1}$  were analyzed in greater detail (see Fig. 9). An extra scattering in the range from  $460$  to  $490\text{ cm}^{-1}$  observed in samples  $G_2$  and  $G_2^1$  capped with a-Si (arrow in Fig. 2) appears as a result of effective density of transverse optical (TO) vibration modes in a-Si:H,<sup>49</sup> and thus, it can be attributed to the amorphous silicon phase.

The analysis of the spectra shown in Fig. 9 followed a three-peak fitting centered at  $\approx 520\text{ cm}^{-1}$ ,  $500 \pm 10\text{ cm}^{-1}$ , and  $480 \pm 10\text{ cm}^{-1}$ , corresponding to the TO phonon of c-Si, defective part of the crystalline phase or a fine crystalline phase in the layer,<sup>50–53</sup> and amorphous contributions, respectively (solid lines in Fig. 9). The crystallinity factor was calculated by  $f_c = (I_{500} + I_{520})/(I_{500} + I_{520} + 0.8I_{480})$ ,<sup>54</sup> where

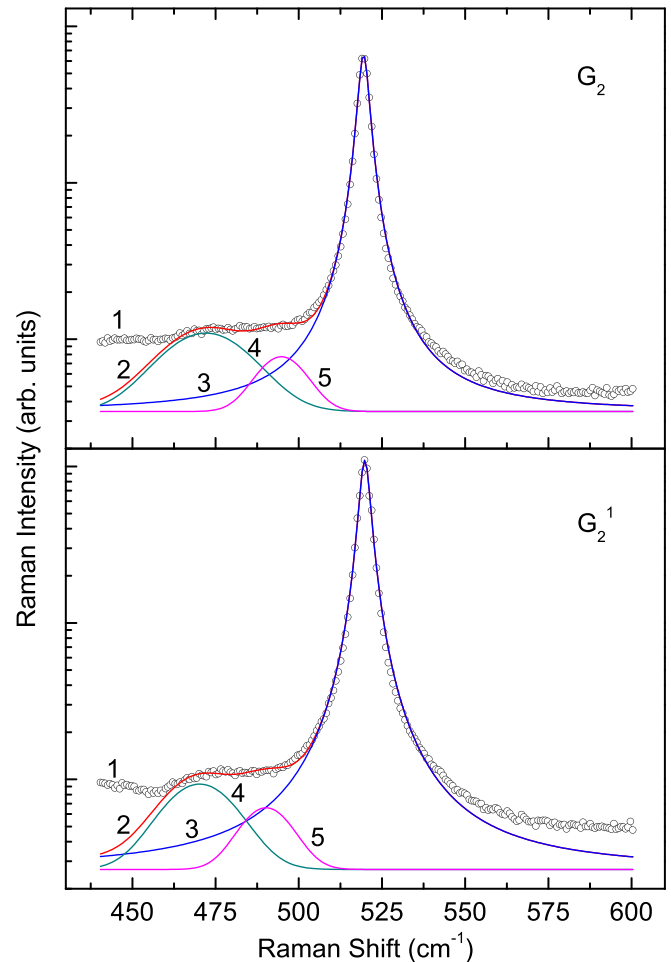


FIG. 9. Raman spectra (curves 1) of samples  $G_2$  and  $G_2^1$  (portions of spectra 2 and 3 in Fig. 2 enlarged in the range from  $440$  to  $600\text{ cm}^{-1}$ ). The data fits (curves 2) consist of the sums of a Lorentzian peak function at  $520\text{ cm}^{-1}$  (curves 3) and Gaussian peak functions at  $480 \pm 10$  (curves 4) and  $500 \pm 10\text{ cm}^{-1}$  (curves 5).



$I$  is the area of each respective peak. We got  $f_c = 0.99$  in sample G, 0.95 in sample G<sub>2</sub>, and 0.98 in sample G<sub>2</sub><sup>1</sup>.

It is apparent that capping with a-Si decreases  $f_c$  in sample G<sub>2</sub> due to a thin amorphous layer. Sample G<sub>2</sub><sup>1</sup> has less a-Si content than sample G<sub>2</sub> but still less crystal fraction than sample G due probably to microcrystallization, which occurs after annealing at 400 °C.

It was also reported that atomic and molecular chains possessing micro voids would affect the density of localized states, which act as efficient recombination centers.<sup>55</sup> It turns out that there may be ways to reduce the density of states by increasing the annealing temperature, which is accompanied by orders of magnitude increase in the recombination lifetime of the majority carriers.<sup>56</sup> Therefore, a segregation of hydrogen atoms around the voids, which are organized in coordinated networks and reorganized during annealing,<sup>57–59</sup> may hence explain part of the experimental results on  $\tau_0$  (see Fig. 3), discussed earlier.

#### IV. CONCLUSIONS

In summary, we report the enhanced photovoltage in Ge<sub>x</sub>Si<sub>1-x</sub>-on-Si nanostructures after their capping with a thin amorphous silicon layer and a subsequent annealing at 400 °C in an O<sub>2</sub> ambient atmosphere. It is found that the surface photovoltage can be enhanced by up to 10 times as compared with the SPV signal observed in unannealed samples, which provides an excellent opportunity for solar cell applications. The increase in the SPV magnitude is accompanied by a prolonged SPV decay time, being greatly increased after the annealing step. These results can be used to engineer silicon-germanium based photovoltaic materials with high efficiency.

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